

Customer	WTL
	Approved by:XoXo Lee
	Checked by: Susan He
	Issued by: Sheryl Xia

SPECIFICATION

深圳市维拓精电科技有限公司

Shenzhen WTL Electronic Technology Co.,Ltd Tel: 86-755-8267 7582 Fax:86-755-8267 9302

www.wtlcrystals.com email: wtl@wtlcrystals.com

P/N: WTL6A20842 SAW RESONATOR 3.2*2.5mm

1. Scope

This specification shall cover the characteristics of 1-port SAW resonator with R433M used for remote-control security.

2. Electrical Specification

2.1 Maximum Rating

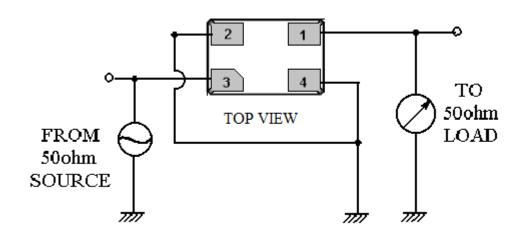
DC Voltage VDC	10V			
AC Voltage Vpp	10V 50Hz/60Hz			
Operation temperature	-40°C to +85°C			
Storage temperature	-45°C to +85°C			
Max Input Power	10dBm			

2.2 Electronic Characteristics

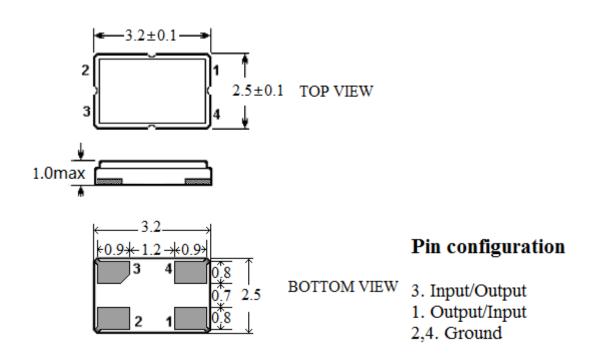
Item		Unites	Minimum	Typical	Maximum	
Center Frequency			MHz	433.845	433.920	433.995
Insertion Loss			dB		1.8	2.2
Quality Factor $\frac{\text{Unload Q}}{50\Omega \text{ Loaded Q}}$		Unload Q		8300	12000	
		50Ω Loaded Q		850	1500	
Temperature	Turnover Temperature		$^{\circ}$	10	25	40
Stability Freq.te		mp.Coefficient	ppm/℃		0.032	
Frequency Aging		ppm/yr		<±10		
DC. Insulation Resistance		ΜΩ	1.0			
RF	Motional Resistance R1		Ω		18	26
Equivalent	Motional Inductance L1		μН		79.82	
RLC Model Motional Capacitance C1		fF		1.685		
Transducer Static Capacitance C0		pF		2.3		



3. TEST CIRCUIT



4. DIMENSION



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5. Environment Characteristic

5-1 High temperature exposure

Subject the device to +85°C for 16 hours. Then release the filter into the room conditions for 24 hours prior to the measurement. It shall fulfill the specifications in 2-2.

5-2 Low temperature exposure

Subject the device to -40°C for 16 hours. Then release the device into the room conditions for 24 hours prior to the measurement. It shall fulfill the specifications in 2-2.

5-3 Temperature cycling

Subject the device to a low temperature of -40°C for 30 minutes. Following by a high temperature of +85°C for 30 Minutes. Then release the device into the room conditions

for 24 hours prior to the measurement. It shall meet the specifications in 2-2. 5-

4 Resistance to solder heat

Dip the device terminals no closer than 1.5mm into the solder bath at 260° C $\pm 10^{\circ}$ C for 10 ± 1 sec. Then release the device into the room conditions for 4 hours. The device shall meet the specifications in 2-2.

5-5 olderability

Subject the device terminals into the solder bath at 245° C $\pm 5^{\circ}$ C for 5s, More than 95% area of the terminals must be covered with new solder. It shall meet the specifications in 2-2

5-6 echanical shock

Drop the device randomly onto the concrete floor from the height of 1m 3 times. the device shall fulfill the specifications in 2-2.

5-7 Vibration

Subject the device to the vibration for 1 hour each in x,y and z axes with the amplitude of 1.5 mm at 10 to 55 Hz. The device shall fulfill the specifications in 2-2.

6. Remark

6.1 Static voltage

Static voltage between signal load & ground may cause deterioration &destruction of the component. Please avoid static voltage.

6.2 Ultrasonic cleaning

Ultrasonic vibration may cause deterioration & destruction of the component. Please avoid ultrasonic cleaning

6.3 Soldering

Only leads of component may be soldered. Please avoid soldering another part of component.

7. Packing

7.1 Dimensions

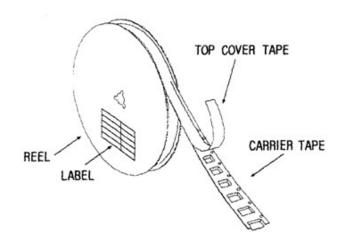
- Carrier Tape: Figure 1
- Reel: Figure 2
- The product shall be packed properly not to be damaged during transportation and storage.

7.2 Reeling Quantity

3000 pcs/reel 7"

7.3 Taping Structure

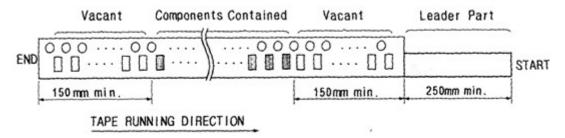
• The tape shall be wound around the reel in the direction shown below.



• Label

Device Name	
User Product Name	
Quantity	
Lot No.	

• Leader part and vacant position specifications.



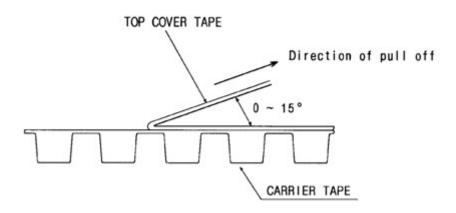
8. TAPE SPECIFICATIONS

8.1 Tensile Strength of Carrier Tape: 4.4N/mm width

8.2 Top Cover Tape Adhesion (See the below figure)

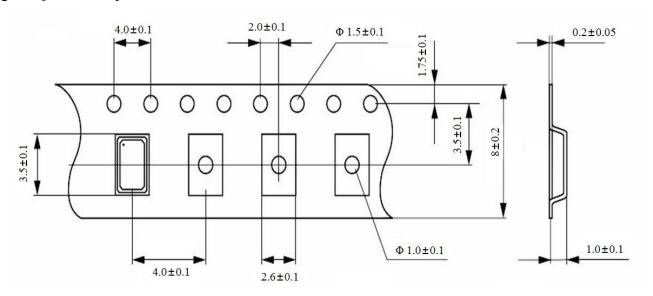
pull off angle: 0~15°
speed: 300mm/min.

• force: 20~70g





[Figure 1] Carrier Tape Dimensions



[Figure 2] 3000 pcs/reel

